

# 74AVC16834A

18-bit registered driver with inverted register enable and Dynamic Controlled Outputs; 3-state

Rev. 6 — 12 September 2018

Product data sheet

## 1. General description

The 74AVC16834A is an 18-bit universal bus driver. Data flow is controlled by output enable ( $\overline{OE}$ ), latch enable ( $\overline{LE}$ ) and clock inputs (CP).

This product is designed to have an extremely fast propagation delay and a minimum amount of power consumption.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor (Live Insertion).

A Dynamic Controlled Output (DCO) circuitry is implemented to support termination line drive during transient. See [Fig. 5](#) for typical curves.

## 2. Features and benefits

- Wide supply voltage range from 1.2 V to 3.6 V
- Complies with JEDEC standards:
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8-1A (2.7 V to 3.6 V)
- CMOS low power consumption
- Input/output tolerant up to 3.6 V
- Dynamic Controlled Output (DCO) circuit dynamically changes output impedance, resulting in noise reduction without speed degradation
- Low inductance multiple  $V_{CC}$  and GND pins to minimize noise and ground bounce
- Power off disables 74AVC16834A outputs, permitting Live Insertion
- Integrated input diodes to minimize input overshoot and undershoot

## 3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AVC16834ADGG	-40 °C to + 85 °C	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1

4. Functional diagram

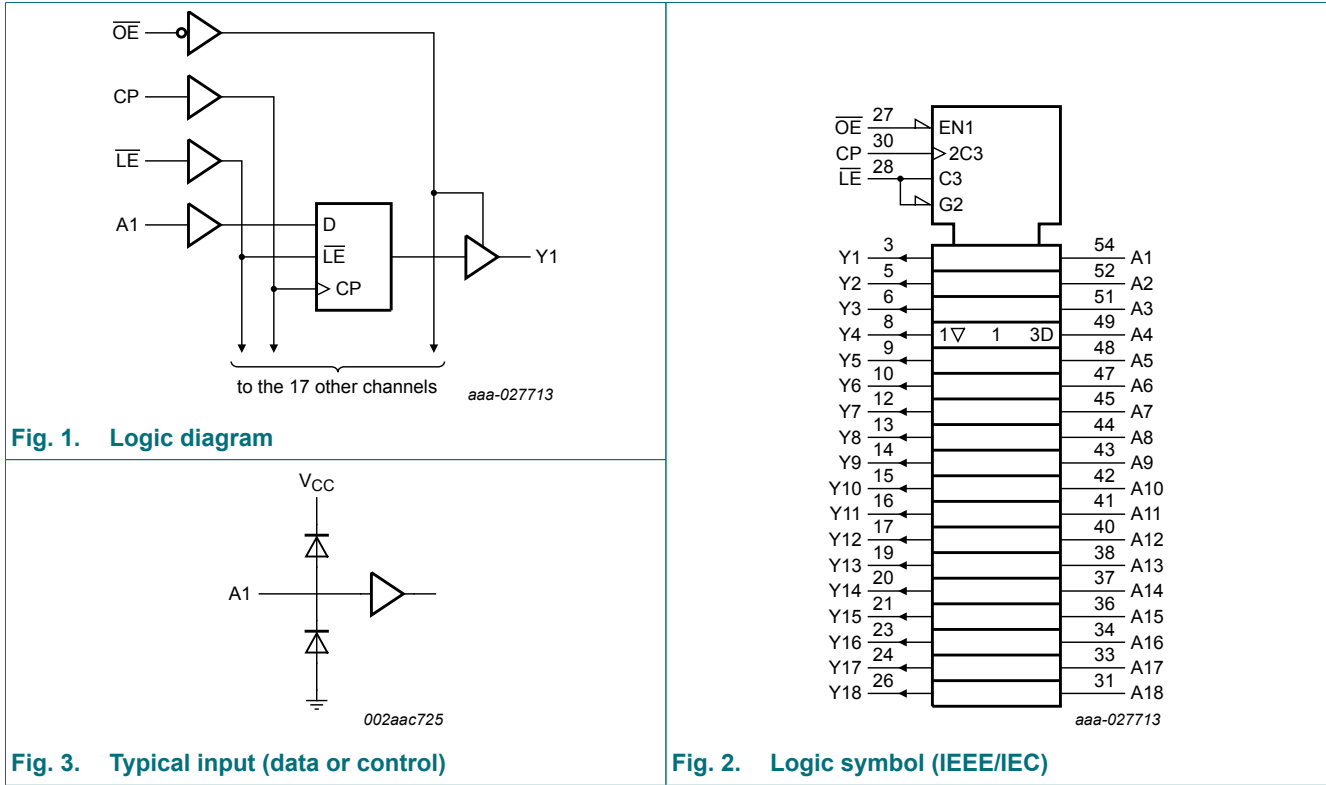


Fig. 1. Logic diagram

Fig. 3. Typical input (data or control)

Fig. 2. Logic symbol (IEEE/IEC)

## 5. Pinning information

### 5.1. Pinning

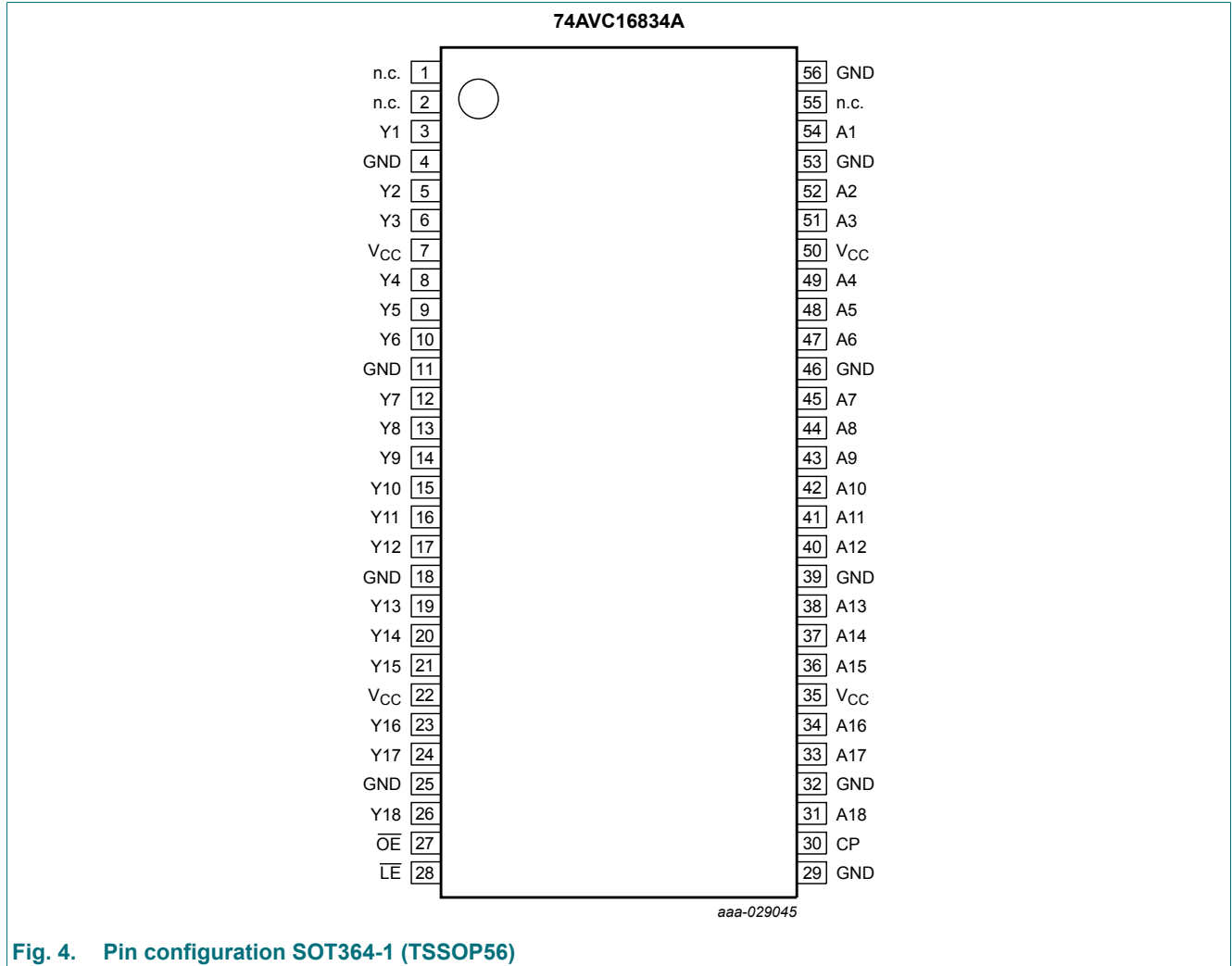


Fig. 4. Pin configuration SOT364-1 (TSSOP56)

## 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
OE	27	output enable input (active LOW)
Y1, Y2, Y3, Y4, Y5, Y6, Y7, Y8, Y9, Y10, Y11, Y12, Y13, Y14, Y15, Y16, Y17, Y18	3, 5, 6, 8, 9, 10, 12, 13, 14, 15, 16, 17, 19, 20, 21, 23, 24, 26	data output
GND	4, 11, 18, 25, 32, 39, 46, 53, 56	ground supply (0 V)
V <sub>CC</sub>	7, 22, 35, 50	supply voltage
n.c.	1, 2, 55	not connected
LE	28	latch enable input (active LOW)
A1, A2, A3, A4, A5, A6, A7, A8, A9, A10, A11, A12, A13, A14, A15, A16, A17, A18	54, 52, 51, 49, 48, 47, 45, 44, 43, 42, 41, 40, 38, 37, 36, 34, 33, 31	data input
CP	30	clock input

## 6. Functional description

Table 3. Function selection

H = HIGH voltage level; L = LOW voltage level; X = Don't care; Z = high-impedance OFF-state; ↑ = LOW to HIGH level transition.

Inputs				Outputs
OE	LE	CP	An	Yn
H	X	X	X	Z
L	L	X	L	L
L	L	X	H	H
L	H	↑	L	L
L	H	↑	H	H
L	H	H	X	Y <sub>0</sub> [1]
L	H	L	X	Y <sub>0</sub> [2]

- [1] Output level before the indicated steady-state input conditions were established, provided that CP is high before LE goes low.  
 [2] Output level before the indicated steady-state input conditions were established.

## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit	
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V	
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA	
V <sub>I</sub>	input voltage	[1]	-0.5	+4.6	V	
I <sub>OK</sub>	output clamping current	V <sub>O</sub> > V <sub>CC</sub> or V <sub>O</sub> < 0 V	-	±50	mA	
V <sub>O</sub>	output voltage	output HIGH or LOW	[1]	-0.5	V <sub>CC</sub> + 0.5	V
		output 3-state	[1]	-0.5	+4.6	V
I <sub>O</sub>	output current	V <sub>O</sub> = 0 V to V <sub>CC</sub>	-	±50	mA	
I <sub>CC</sub>	supply current		-	100	mA	

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Symbol	Parameter	Conditions	Min	Max	Unit
$I_{\text{GND}}$	ground current		-100	-	mA
$T_{\text{stg}}$	storage temperature		-65	+150	°C
$P_{\text{tot}}$	total power dissipation	$T_{\text{amb}} = -40\text{ °C to }+85\text{ °C}$ [2]	-	600	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] Above 55 °C the value of  $P_{\text{tot}}$  derates linearly with 8 mW/K.

## 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{\text{CC}}$	supply voltage	for low-voltage applications	1.2	-	3.6	V
		according to JEDEC Low Voltage Standards	1.65	-	1.95	V
			2.3	-	2.7	V
			3.0	-	3.6	V
$V_{\text{I}}$	input voltage	0	-	3.6	V	
$V_{\text{O}}$	output voltage	output HIGH or LOW	0	-	$V_{\text{CC}}$	V
		output 3-state	0	-	3.6	V
$T_{\text{amb}}$	ambient temperature	in free air	-40	-	+85	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{\text{CC}} = 1.65\text{ V to }2.3\text{ V}$	0	-	30	ns/V
		$V_{\text{CC}} = 2.3\text{ V to }3.0\text{ V}$	0	-	20	ns/V
		$V_{\text{CC}} = 3.0\text{ V to }3.6\text{ V}$	0	-	10	ns/V

## 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions;  $T_{\text{amb}} = -40\text{ °C to }+85\text{ °C}$ ; Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
$V_{\text{IH}}$	HIGH-level input voltage	$V_{\text{CC}} = 1.2\text{ V}$	$V_{\text{CC}}$	-	-	V
		$V_{\text{CC}} = 1.65\text{ V to }1.95\text{ V}$	$0.65 \times V_{\text{CC}}$	0.9	-	V
		$V_{\text{CC}} = 2.3\text{ V to }2.7\text{ V}$	1.7	1.2	-	V
		$V_{\text{CC}} = 3.0\text{ V to }3.6\text{ V}$	2.0	1.5	-	V
$V_{\text{IL}}$	LOW-level input voltage	$V_{\text{CC}} = 1.2\text{ V}$	-	-	GND	V
		$V_{\text{CC}} = 1.65\text{ V to }1.95\text{ V}$	-	0.9	$0.35 \times V_{\text{CC}}$	V
		$V_{\text{CC}} = 2.3\text{ V to }2.7\text{ V}$	-	1.2	0.7	V
		$V_{\text{CC}} = 3.0\text{ V to }3.6\text{ V}$	-	1.5	0.8	V
$V_{\text{OH}}$	HIGH-level output voltage	$V_{\text{I}} = V_{\text{IH}} \text{ or } V_{\text{IL}}$				
		$I_{\text{O}} = -100\text{ }\mu\text{A}; V_{\text{CC}} = 1.65\text{ V to }3.6\text{ V}$	$V_{\text{CC}} - 0.20$	$V_{\text{CC}}$	-	V
		$I_{\text{O}} = -4\text{ mA}; V_{\text{CC}} = 1.65\text{ V}$	$V_{\text{CC}} - 0.45$	$V_{\text{CC}} - 0.10$	-	V
		$I_{\text{O}} = -8\text{ mA}; V_{\text{CC}} = 2.3\text{ V}$	$V_{\text{CC}} - 0.55$	$V_{\text{CC}} - 0.28$	-	V
		$I_{\text{O}} = -12\text{ mA}; V_{\text{CC}} = 3.0\text{ V}$	$V_{\text{CC}} - 0.70$	$V_{\text{CC}} - 0.32$	-	V

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Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	-	GND	0.20	V
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V	-	0.10	0.45	V
		I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V	-	0.26	0.55	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 3.0 V	-	0.36	0.70	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 1.65 V to 3.6 V	-	0.1	2.5	μA
I <sub>OFF</sub>	power-off leakage current	V <sub>I</sub> or V <sub>O</sub> = 3.6 V; V <sub>CC</sub> = 0 V	-	0.1	±10	μA
I <sub>IHZ</sub> /I <sub>ILZ</sub>	power-off leakage current	V <sub>CC</sub> = 1.65 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND	-	0.1	12.5	μA
I <sub>OZ</sub>	OFF-state output current	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = V <sub>CC</sub> or GND				
		V <sub>CC</sub> = 1.65 V to 2.7 V	-	0.1	5	μA
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	0.1	10	μA
I <sub>CC</sub>	supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A				
		V <sub>CC</sub> = 1.65 V to 2.7 V	-	0.1	20	μA
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	0.2	40	μA
C <sub>I</sub>	input capacitance		-	5.0	-	pF

[1] All typical values are measured at T<sub>amb</sub> = 25 °C.

### 9.1. Dynamic Controlled Output graphs

A Dynamic Controlled Output (DCO) circuit is designed in. During the transition, it initially lowers the output impedance to effectively drive the load and, subsequently, raises the impedance to reduce noise. Fig. 5 shows V<sub>OL</sub> vs. I<sub>OL</sub> and V<sub>OH</sub> vs. I<sub>OH</sub> curves to illustrate the output impedance and drive capability of the circuit. At the beginning of the signal transition, the DCO circuit provides a maximum dynamic drive that is equivalent to a high drive standard output device.

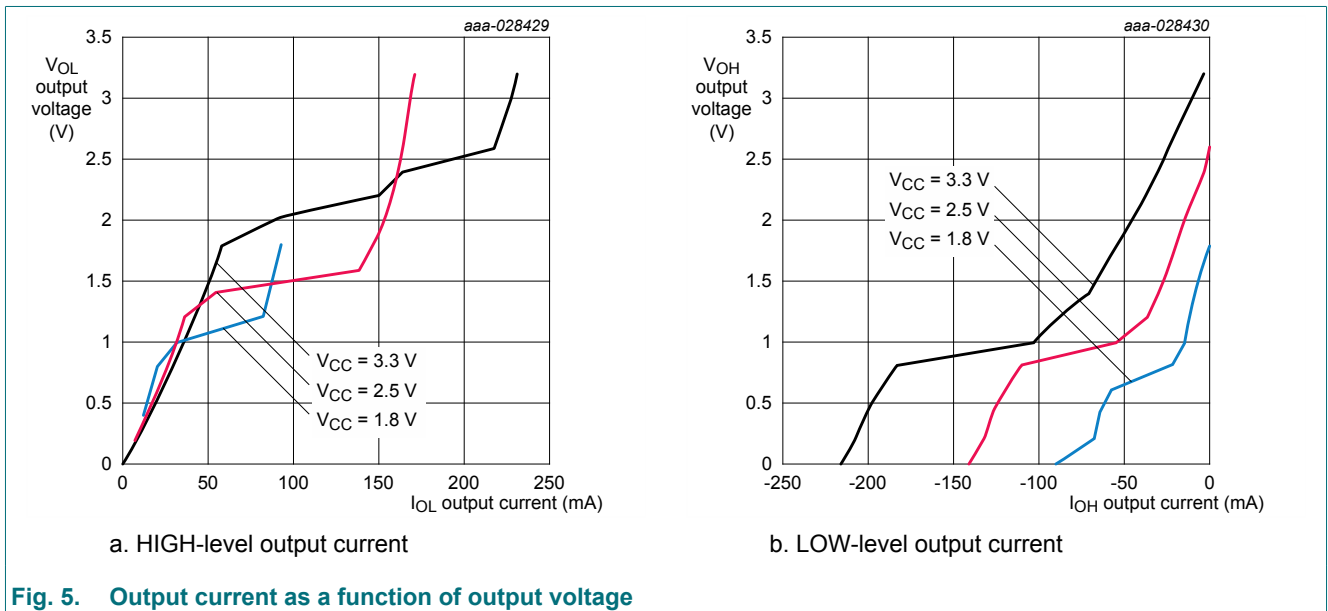


Fig. 5. Output current as a function of output voltage

## 10. Dynamic characteristics

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Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 12.

Symbol	Parameter	Conditions	V <sub>CC</sub> =	V <sub>CC</sub> =			V <sub>CC</sub> =			V <sub>CC</sub> =			V <sub>CC</sub> =			Unit
			1.2 V	1.4 V to 1.6 V			1.65 V to 1.95 V			2.3 V to 2.7 V			3.0 V to 3.6 V			
			Typ	Min	Typ [1]	Max	Min	Typ [1]	Max	Min	Typ [1]	Max	Min	Typ [1]	Max	
t <sub>PHL</sub>	HIGH to LOW propagation delay	An to Y <sub>n</sub> ; see Fig. 6	5.9	2.0	3.6	5.8	1.5	2.8	4.9	1.0	2.0	3.2	0.9	1.7	2.6	ns
		$\overline{\text{LE}}$ to Y <sub>n</sub> ; see Fig. 7	6.5	2.3	4.0	6.5	1.8	3.4	5.3	1.5	2.4	3.7	1.2	2.0	3.0	ns
		CP to Y <sub>n</sub> ; see Fig. 9	4.9	2.0	3.7	5.1	1.6	2.8	4.4	1.1	2.0	3.0	0.8	1.7	2.5	ns
t <sub>PLH</sub>	LOW to HIGH propagation delay	An to Y <sub>n</sub> ; see Fig. 6	5.2	2.0	3.6	5.8	1.0	2.6	4.5	0.8	2.0	3.0	0.7	1.7	2.5	ns
		$\overline{\text{LE}}$ to Y <sub>n</sub> ; see Fig. 7	5.8	2.3	4.0	6.5	1.0	2.9	5.3	0.8	2.3	3.5	0.7	1.9	2.9	ns
		CP to Y <sub>n</sub> ; see Fig. 9	5.2	2.0	3.7	5.1	1.0	2.6	4.5	0.8	2.0	3.0	0.7	1.7	2.5	ns
t <sub>PZH</sub>	OFF-state to HIGH propagation delay	$\overline{\text{OE}}$ to Y <sub>n</sub> ; see Fig. 11	8.0	2.8	5.0	8.2	2.2	4.0	6.7	1.6	2.8	4.8	1.3	2.5	4.3	ns
t <sub>PZL</sub>	OFF-state to LOW propagation delay	$\overline{\text{OE}}$ to Y <sub>n</sub> ; see Fig. 11	5.5	2.8	5.0	8.2	1.5	3.0	6.5	1.0	2.5	4.5	1.0	2.3	4.0	ns
t <sub>PHZ</sub>	HIGH to OFF-state propagation delay	$\overline{\text{OE}}$ to Y <sub>n</sub> ; see Fig. 11	6.5	2.1	4.5	6.9	2.4	4.6	7.2	1.5	3.4	5.6	1.5	3.0	4.7	ns
t <sub>PLZ</sub>	LOW to OFF-state propagation delay	$\overline{\text{OE}}$ to Y <sub>n</sub> ; see Fig. 11	5.5	2.1	4.5	6.9	1.5	3.5	6.5	1.0	2.2	4.0	1.0	2.3	3.5	ns
t <sub>w</sub>	pulse width	CP HIGH or LOW; see Fig. 9.	-	-	-	-	2.0	-	-	1.2	-	-	1.0	-	-	ns
		$\overline{\text{LE}}$ HIGH; see Fig. 7.	-	-	-	-	2.0	-	-	1.2	-	-	1.0	-	-	ns
t <sub>su</sub>	set-up time	An to CP; see Fig. 10	0.0	0.2	0.0	-	0.0	-0.2	-	0.1	-0.2	-	0.3	-0.5	-	ns
		An to $\overline{\text{LE}}$ ; see Fig. 8	1.5	1.5	0.8	-	1.0	0.5	-	0.6	0.1	-	0.5	0.1	-	ns
t <sub>h</sub>	hold time	An to CP; see Fig. 10	0.1	0.6	0.3	-	0.7	0.3	-	0.7	0.3	-	0.9	0.6	-	ns
		An to $\overline{\text{LE}}$ ; see Fig. 8	-0.7	0.1	0.0	-	0.1	0.0	-	0.2	0.1	-	0.6	0.4	-	ns
f <sub>max</sub>	maximum frequency	CP; see Fig. 9	-	-	-	-	250	-	-	400	-	-	500	-	-	MHz

[1] Typical values are measured at T<sub>amb</sub> = 25 °C and V<sub>CC</sub> = 1.5 V, 1.8 V, 2.5 V and 3.3 V respectively.

Table 8. Power dissipation capacitance

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
C <sub>PD</sub>	power dissipation capacitance	per buffer; V <sub>I</sub> = GND to V <sub>CC</sub>	[1]			
		outputs enabled	-	25	-	pF
		outputs disabled	-	6	-	pF

- [1] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).  
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:  
 f<sub>i</sub> = input frequency in MHz;  
 f<sub>o</sub> = output frequency in MHz  
 C<sub>L</sub> = output load capacitance in pF  
 V<sub>CC</sub> = supply voltage in Volts  
 N = number of inputs switching  
 Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) = sum of the outputs.

### 10.1. Waveforms and test circuit

Measurement points are given in Table 9.  
 VOL and VOH are typical voltage output levels that occur with the output load.

**Fig. 6. Input (An) to output (Yn) propagation delay**

Measurement points are given in Table 9.  
 VOL and VOH are typical voltage output levels that occur with the output load.

**Fig. 7. LE input pulse width, LE input to Yn output propagation delays**

Measurement points are given in Table 9.  
 The shaded areas indicate when the input is permitted to change for predictable output performance.

**Fig. 8. Data set-up and hold times, An input to LE input**

Measurement points are given in Table 9.  
 VOL and VOH are typical voltage output levels that occur with the output load.

**Fig. 9. CP to Yn propagation delays, clock pulse width, and maximum clock frequency**



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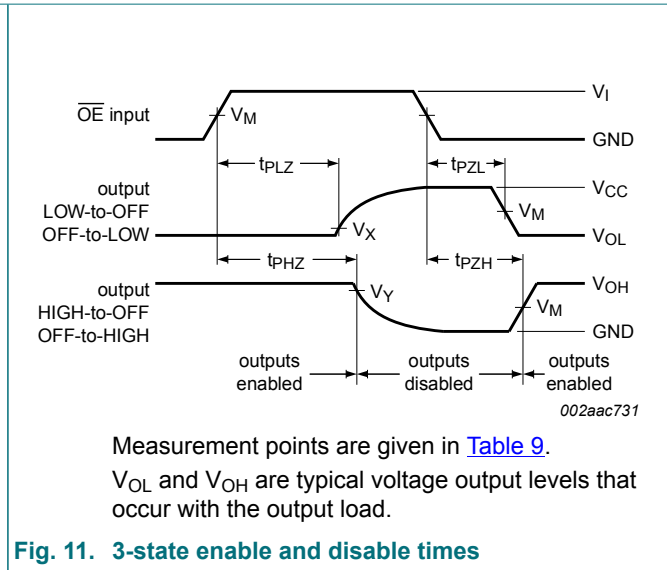
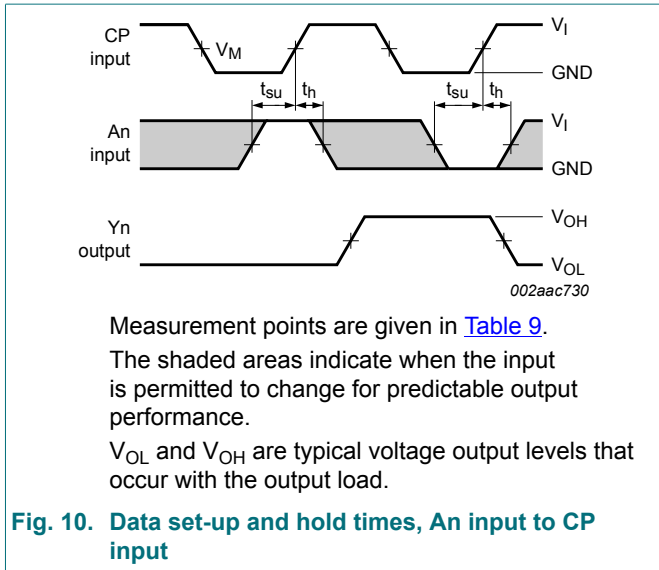
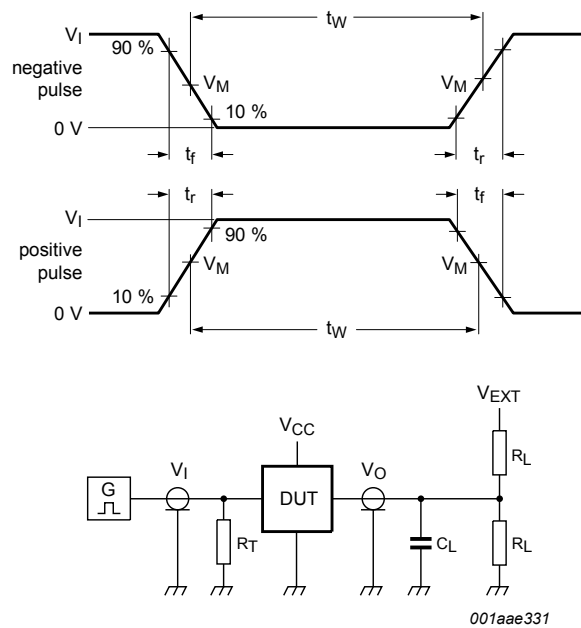


Table 9. Measurement points

Supply voltage	Input		Output		
$V_{CC}$	$V_I$	$V_M$	$V_M$	$V_X$	$V_Y$
$\leq 2.3\text{ V}$	$V_{CC}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15\text{ V}$	$V_{OH} - 0.15\text{ V}$
2.3 V to 2.7 V	$V_{CC}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15\text{ V}$	$V_{OH} - 0.15\text{ V}$
3.0 V to 3.6 V	$V_{CC}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.3\text{ V}$	$V_{OH} - 0.3\text{ V}$

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Test data is given in [Table 10](#).

Definitions for test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$V_{EXT}$  = External voltage for measuring switching times.

**Fig. 12. Test circuit for measuring switching times**

**Table 10. Test data**

Supply voltage	Input		Load		$V_{EXT}$		
$V_{CC}$	$V_I$	$t_r, t_f$	$C_L$	$R_L$	$t_{PLH}, t_{PHL}$	$t_{PLZ}, t_{PZL}$	$t_{PHZ}, t_{PZH}$
$\leq 2.3$ V	$V_{CC}$	$\leq 2.0$ ns	30 pF	1000 $\Omega$	open	2 x $V_{CC}$	GND
2.3 V to 2.7 V	$V_{CC}$	$\leq 2.0$ ns	30 pF	500 $\Omega$	open	2 x $V_{CC}$	GND
3.0 V to 3.6 V	$V_{CC}$	$\leq 2.0$ ns	30 pF	500 $\Omega$	open	2 x $V_{CC}$	GND

### 11. Package outline

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm

SOT364-1

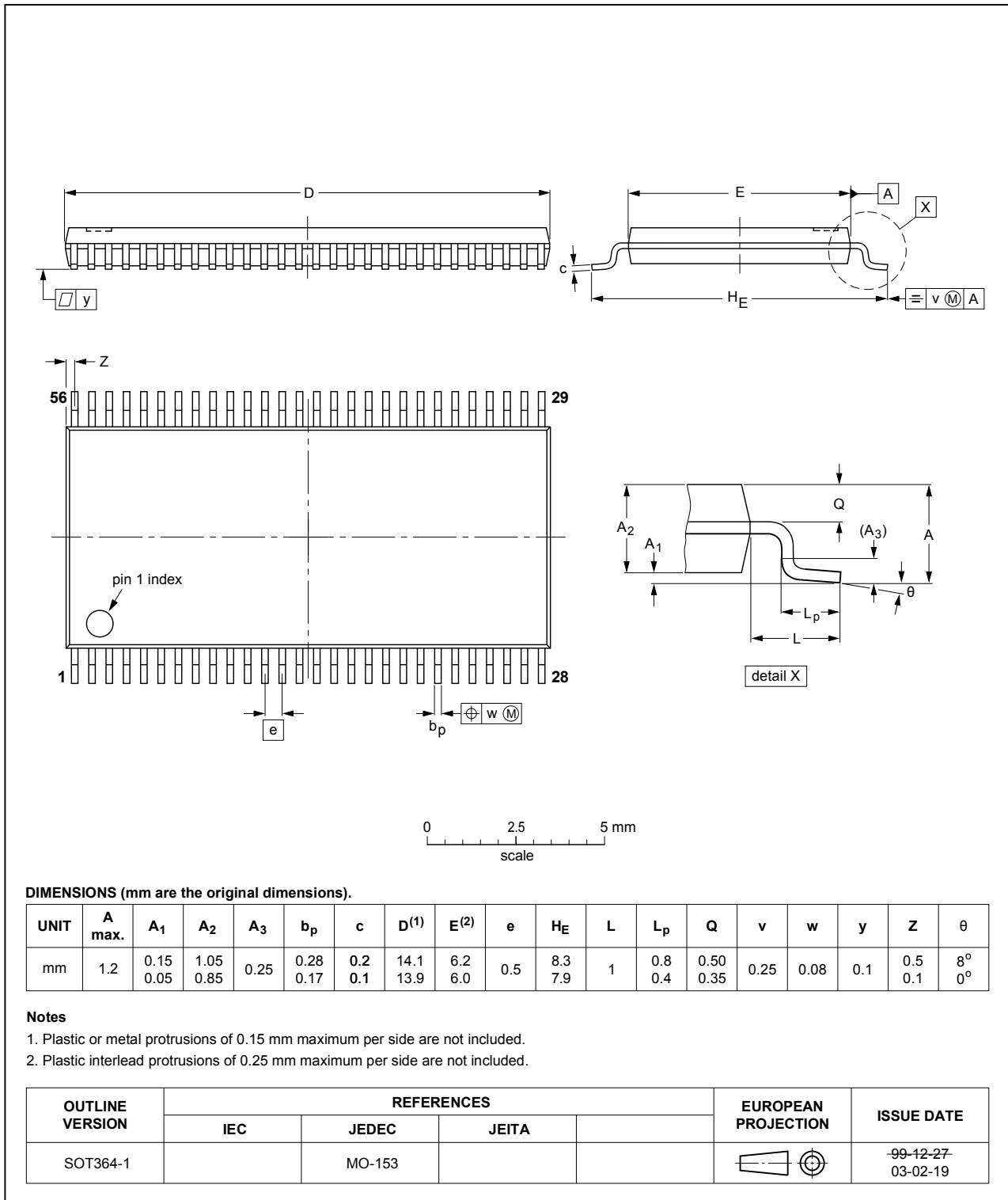


Fig. 13. Package outline SOT364-1 (TSSOP56)

## 12. Abbreviations

Table 11. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DCO	Dynamic Controlled Output
DUT	Device Under Test

## 13. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AVC16834A v.6	20180912	Product data sheet	-	74AVC16834A v.5
Modifications:	<ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Type number 74AVC16834ADGV (SOT481-2) removed.</li> </ul>			
74AVC16834A v.5	20020911	Product data sheet	-	74AVC16834A v.4
Modifications:	<ul style="list-style-type: none"> <li>Type number 74AVC16834ADGV (SOT481-2) added.</li> </ul>			
74AVC16834A v.4	20000725	Product specification	-	74AVC16834A v.3
74AVC16834A v.3	20000502	Preliminary specification	-	74AVC16834 v.2
74AVC16834 v.2	19990723	Preliminary specification	-	74AVC_AVCH16834 v.1
74AVC_AVCH16834 v.1	19990405	Preliminary specification	-	-

## 14. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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